

**Amendments to the Specification:**

Please add the following new paragraph before line 1 of page 1:

TITLE

Please add the following new paragraph after the paragraph ending on line 2 of page 1:

CROSS REFERENCE TO RELATED APPLICATIONS

The present application claims priority to Japanese Patent Document No. P2003-337113 filed on September 29, 2003, the disclosure of which is herein incorporated by reference.

Please delete the following subtitle on line 3 of page 1:

~~Technical Field~~

Please delete the following subtitle on line 11 of page 1:

~~Background Art~~

Please delete the following subtitle on line 22 of page 2:

~~Disclosure of the Invention~~

Please add the following new Title after the paragraph ending on line 6 of page 5:

SUMMARY

Please replace the paragraph beginning at page 6, line 24 with the following rewritten paragraph:

Yet, according to this invention in an embodiment, a thermal transfer recording method comprising the steps of bringing a receiving material in contact with a sublimation thermal transfer recording medium, applying heat from a back surface of the sublimation thermal transfer recording medium, and effecting printing on the receiving material is characterized in using the sublimation thermal transfer recording medium formed with a thermal transfer dye layer containing a phenoxy resin as a main binder resin and containing a block copolymer silicone resin and in printing directly a surface of a soft vinyl chloride card as the receiving material.

Please replace the paragraph beginning at page 7, line 8 with the following rewritten paragraph:

As described above, use of the sublimation thermal transfer recording medium according to this invention in an embodiment enables high density printing and eliminates the problem of background stain. Therefore, even when the receiving material is a soft vinyl chloride card, such printing can be realized, as having sufficient coloring density and accurate gradation owing to high correlation between the applied heat quantity and the coloring density.

Please replace the paragraph beginning at page 7, line 15 with the following rewritten paragraph:

According to this invention in an embodiment, the background stain and the like can be solved and printing with accurate gradation owing to high correlation between the applied heat quantity and the coloring density can be realized. Furthermore, such problems can be effectively eliminated upon formation of the thermal transfer dye layer, as separation of the dye and repealing thereof upon coating the thermal transfer dye layer.

Please add the following new paragraph after the paragraph ending at line 19 on page 7:

Additional features and advantages of the present invention are described in, and will be apparent from, the following Detailed Description and the figures.

Please replace the Title on page 7, line 21 with the following rewritten Title:

~~Brief Description of Drawings~~ BRIEF DESCRIPTION OF THE FIGURES

Please replace the Title on page 8, line 3 with the following rewritten Title:

~~Best Mode for Carrying Out the Invention~~ DETAILED DESCRIPTION

Please replace the paragraph beginning at page 10, line 4 with the following rewritten paragraph:

The polydimethylsiloxane block copolymer is disclosed in detail in Japanese Patent Laid Open No. 10-297123, and those disclosed Japanese Patent Laid Open No. 10-297123 can be used in this invention according to an embodiment.

Please replace the TABLE beginning at page 14, line 4 with the following rewritten TABLE:

	<del>225</del> <u>255</u>	225	200	175	150	75	0
Embodiment 1	0.11	0.12	0.14	0.2	0.28	0.75	1.25
Comparative Example 1	0.11	0.13	0.17	0.28	0.4	0.85	1.28
Comparative Example 2	0.1	0.12	0.15	0.26	0.36	0.79	1.22

Please add the following new paragraph after the paragraph ending at line 11 on page 15:

It should be understood that various changes and modifications to the presently preferred embodiments described herein will be apparent to those skilled in the art. Such changes and modifications can be made without departing from the spirit and scope of the present invention and without diminishing its intended advantages. It is therefore intended that such changes and modifications be covered by the appended claims.